1) AC Coupling of preamplifiers

will allow to operate with higher leakage currents by removing the bias resistors and replacing the caps with shorts will be back to the DC version

2) use new op amps

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OPA687 -> OPA847 (out of production)
THS3001 -> THS3061 (better bandwidth)
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3) add one more ground plane (new total is 8)

signals (top) / ground / V plane / V plane / V plane / V plane / ground / voltage regulators etc. (bottom) need to optimize the 6 voltages (2 X +- 12V, 1 X +- 5 V) over 4 voltage planes: all +12 V (-12 V) on same plane with large gaps, +5V (-5V) on separate planes

- 4) move all signal lines on top plane
- 5) move voltage regulatros on bottom plane
- 6) BNC connectors for output signals much easier handling / reconnect of boards, but will increase width of board and will require support / fixation for the boards
- 7) ground the sub D connector shell
- 8) add LEDs for Voltage regulators
- 9) increase spacing between preamplifier hybrids ( $+ \sim 1$  mm)
- 10) HV: move all HV lines on bottom plane, no embedded lines, use surface mounted bias resistors, more clearance (2 mm) for through holes (will solve HV leakage problems), use 2 pin connectors for HV
- 11) bigger indents for flange screws